



# Zentri AMW036 / AMW136

## Data Sheet



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## About this User Guide

This document provides information on the AMWx36 802.11b/g/n Wi-Fi networking module from Zentri.

Modules covered by this datasheet include:

AMWx36 Rev 2

Further information about ZentriOS is available from:

<http://docs.zentri.com>

## Organization

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## General Features

- Self-contained ultra-low power Wi-Fi module with microcontroller and support for ZentriOS-W firmware (AMW036/AMW136) and ZentriOS-WZ firmware (AMW136), including industry standard SSL/TLS secure TCP/IP network stack.
- Integrated SPI-serial flash for software upgrades and user accessible read/write file system

### Wi-Fi

- Cypress single band 2.4GHz IEEE 802.11b/g/n 1x1 Wi-Fi transceiver
- Includes support for all Wi-Fi security modes including Open, WEP, WPA, and WPA2-PSK

### Microprocessor

- ARM Cortex® M4 based microprocessor
- AMW036: operates up to 84MHz core frequency
- AMW136: operates up to 100MHz core frequency

### RAM

- AMW036: 96 KB
- AMW136: 128 KB

### Interfaces\*

- UART: 2 x 4-wire up to 10.5Mbit/s
- SPI : SPI-Master (42Mbit/s), SPI-Slave (21Mbit/s)
- GPIO: Up to 21 GPIOs (overlaid with peripherals)
- A/D converter: 9 channel input, 12-bit resolution, 2.4MSPS sampling in single-shot or scan mode
- PWM: Up to 14 PWM outputs
- Wake-up: Wake pin for ultra-low power operation
- Built in PCB trace antenna

*\*Some interfaces share module pins*

## Operational & Radio

- Single operating voltage : 3.3V (typical)
- All I/O pins are +5V tolerant
- Operational Temperature Range: -30°C to +85°C
- Size : 20.3 x 22.9 x 3.4mm (0.80" x 0.90" x 0.13")
- Weight : 0.07 oz (2g)
- Current consumption @ 3.3V, 25°C
  - VBAT : 0.97µA (with 32k RTC)
  - Standby : 2.8µA (3.8uA with 32k RTC)
  - Stop : 10µA with RAM retention (113µs wake)
  - Wi-Fi Powersave : 0.77mA (DTIM = 3)
  - Active receive : 5.7mA @ 1Mbit/s UDP
- Active transmit : 11.4mA @ 1Mbit/s UDP
- Maximum RF transmit power
  - 802.11b/g : +18 dBm
  - 802.11n : +14 dBm
- Minimum Receive sensitivity
  - 802.11b/g : -94 dBm
  - 802.11n : -86 dBm
- Sustained TCP throughput : 10 Mbit/s

## Applications

- Industrial, M2M and Home Automation
  - Environmental monitoring
  - Energy monitoring
  - Wireless sensing, remote data logging
  - HVAC, power, light, & thermostat control
  - Appliance control
- Security
  - Cameras, Doors/Window monitoring
  - Alarms, Smoke Detectors
  - Door and entry control
- Health & Fitness
  - Fitness Equipment
  - Home health monitoring e.g. weight scales
- Consumer
  - Audio, Toys, Robots

## ZentriOS-W/ZentriOS-WZ Firmware Features

The ZentriOS-W/ZentriOS-WZ firmware supplied with the AMWx36 provides a wide range of features beyond the underlying hardware, and supports application development via its command API.

For complete documentation of ZentriOS-W, see:

<https://docs.zentri.com/zentrios/w/latest/>

The AMW136 supports ZentriOS-WZ firmware, which adds support for developing ZentriOS apps (ZAPs).

For complete documentation of ZentriOS-WZ, see:

<https://docs.zentri.com/zentrios/wz/latest/>

### Software APIs

- [ZentriOS-W command API](#)
- [ZentriOS-WZ command API](#)
- [ZentriOS-WZ SDK and native API](#)

### Interfaces

- Serial (UART, remote terminal)
- SoftAP and WLAN client (concurrent)
- I2C master
- SPI master

### Servers

- TCP/TLS, UDP, HTTP(S), DHCP, DNS
- HTTP(S) Server with RESTful API and Websockets
- Fully customizable mobile responsive Web application with JavaScript and Python libraries

### Clients

- TCP/TLS, UDP, NTP, Secure-SMTP, DHCP, DNS
- HTTP(S) client
- Websocket client

### Setup

- Multiple Wi-Fi setup options, including via serial command and Web setup with SoftAP

### Peripherals and Sensors

- GPIOs for control, indication and monitoring
- I2C-master API for interfacing to external peripherals
- SPI-master API for interfacing to external peripherals
- Automated broadcast and streaming of sensor data
- Local caching of sensor data

### Update and Recovery

Wireless OTA (Over-the-Air) update to remote manage firmware using the Zentri DMS (Device Management Service)

### System Management

- System configuration and monitoring via setting and getting a wide range of variables
- Configurable power states
- Sleep/wake timers

### File System

- Read/write file system with appendable log files
- Storage of large files
- Optional additional bulk serial flash
- HTTP download to file system, HTTP upload from file system

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# 1 General Description

The AMW036 and AMW136 modules from Zentri combine a microcontroller with a BCM43362 Wi-Fi device to provide an advanced stand-alone Wi-Fi and networking solution.

The term **AMWx36** refers to either module.

An integrated module avoids difficult RF layout and enables designers to rapidly embed Wi-Fi and secure networking functionality into virtually any device.

The ZentriOS serial-to-Wi-Fi application, pre-programmed into all modules, may be used to fast-track module integration into end-products.

With dimensions of just 20.3mm x 22.9mm and a wide temperature range, the module is suitable for integration into most embedded applications.

The Wi-Fi device from Cypress includes an integrated RF transmit power amplifier and provides superior Wi-Fi performance and full compatibility with all 2.4GHz 802.11b/g/n Wi-Fi networks. A single PCB antenna is provided to simplify the RF design requirements.

The microprocessor is based on a high-performance ARM® 32-bit Cortex™-M4.

The AMW036/AMW136 microcontroller core operates at a frequency up to 84/100MHz providing up to 125 DMIPS or 1.25 DMIPS/MHz (Dhrystone 2.1).

The AMW036 has 96KB of RAM.

The AMW136 has 128KB of RAM.

The AMWx36 module offers extensive I/O and peripheral interfaces listed below, and provides additional interface combinations by leveraging multiplexing and alternate function capabilities.

- 2 x 4-Wire UART interfaces
- 2 x SPI interfaces (1 master, 1 slave)
- 21 x GPIOs
- 9 x 12-bit A/D converters
- 14 x PWM outputs
- 1 x ultra-low power wake input

The module is powered by a 3.3V power supply, a separate WLAN power supply pin is provided to minimize noise coupling into the WLAN subsystem.

Various powersave modes offer ultra-low power operation. Wake from low power sleep mode is possible using IO pins or the internal real-time clock, and wake from ultra-low power standby mode is achieved using the dedicated wake pin.

The module incorporates a 32.768kHz crystal to maintain an accurate real time clock. A 32kHz clock output is available on a dedicated module pin in both active power save modes. The 32kHz clock output may be used to drive the clock input of other system devices. This avoids the need for an additional crystal thereby minimizing total system cost.

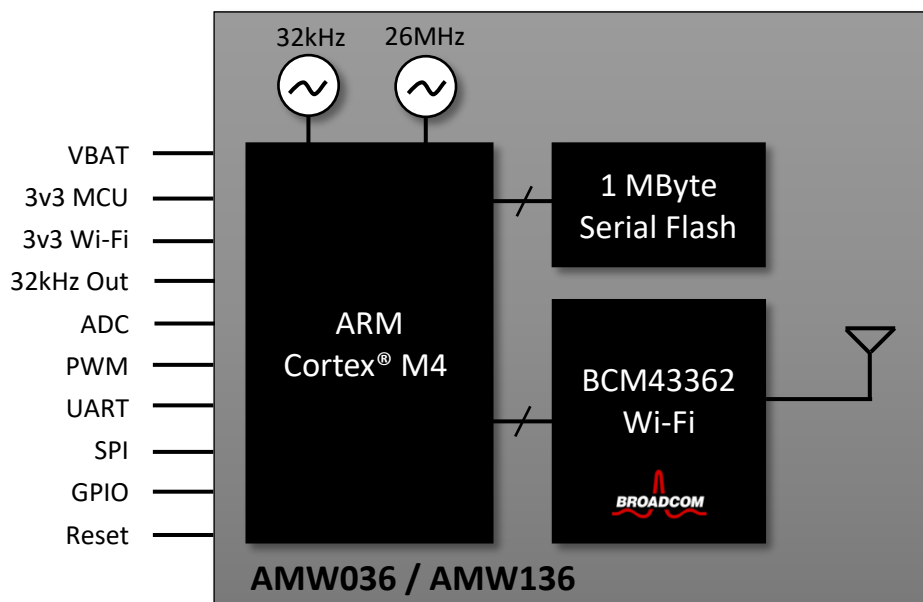
The module has numerous modular approvals. See Section 7, Regulatory Certification.

## 2 Block Diagram

Figure 1 is a block diagram of the AMWx36 module. The main components of the module are a microprocessor and BCM43362 Wi-Fi System-on-Chip (SoC). The processor and peripherals are driven by a 26MHz crystal. The integrated real-time clock (RTC) is driven by a 32.768kHz crystal. An on-board 1MByte serial flash chip may be used to store user data and configuration, additional applications, and firmware images as part of the Zentri secure over the air (OTA) update process.

The WLAN subsystem is controlled by ZentriOS enabling the module to achieve minimum power consumption when the Wi-Fi networking interface is not required. A single PCB antenna is provided to simplify the RF design requirements.

Figure 1. AMW036 / AMW136 Architecture



## 3 Electrical Specifications

### 3.1 Absolute Maximum Ratings

CAUTION! The absolute maximum ratings in Table 1 and Table 2 indicate levels where permanent damage to the device can occur, even if these limits are exceeded for only a brief duration. Functional operation is not guaranteed under these conditions. Operation at absolute maximum conditions for extended periods can adversely affect long-term reliability of the device.

The values in Table 1 reflect absolute maximum ratings from the respective microprocessor and BCM43362 datasheets.

**Table 1. Absolute Maximum Voltage Ratings**

| Symbol          | Ratings   | Min       | Max           | Unit |
|-----------------|---|-----------|---------------|------|
| VBAT            | External power supply voltage to MCU VBAT pin   | -0.3      | 4.0           | V    |
| VDD_3V3         | External power supply voltage to MCU subsystem  | -0.3      | 4.0           |      |
| VDD_WIFI        | External power supply voltage to WLAN subsystem | -0.5      | 6.0           |      |
| V <sub>in</sub> | Input voltage on any other MCU pin              | GND - 0.3 | VDD_3V3 + 4.0 |      |

**Table 2. Absolute Maximum Environmental Ratings**

| Characteristic      | Note                     | Min | Max  | Unit |
|---------------------|--------------------------|-----|------|------|
| Storage Temperature | —                        | -40 | +125 | °C   |
| Storage Humidity    | Non-condensing (storage) | —   | 65   | %    |

### 3.2 Recommended Operating Conditions

Functional operation is not guaranteed outside the limits shown in Table 3 and Table 4, and operation outside these limits for extended periods can adversely affect long-term reliability of the device.

#### 3.2.1 DC Operating Conditions

**Table 3. Recommended DC Operating Conditions**

| Symbol                  | Ratings   | Min | Typ | Max | Unit |
|-------------------------|---|-----|-----|-----|------|
| VBAT                    | External power supply voltage to MCU VBAT pin   | 3.0 | 3.3 | 3.6 | V    |
| VDD_3V3 <sup>1</sup>    | External power supply voltage to MCU subsystem  | 3.0 | 3.3 | 3.6 |      |
| VDD_WIFI <sup>1,2</sup> | External power supply voltage to WLAN subsystem | 3.0 | 3.3 | 3.6 |      |

**Notes:**

1. VDD\_3V3 and VDD\_WIFI must be at the same voltage when using the Wi-Fi subsystem
2. The performance of the Wi-Fi subsystem is degraded significantly at low voltages

### 3.2.2 Environmental Conditions

Table 4. Recommended Environmental Conditions

| Characteristic      | Note                               | Min | Max | Unit |
|---------------------|------------------------------------|-----|-----|------|
| Ambient Temperature | Limited by WLAN chip specification | -30 | +85 | °C   |
| Relative Humidity   | Non-condensing (operating)         | –   | 85  | %    |

## 3.3 Power Consumption

Table 5. Power consumption (VDD\_3V3, VDD\_WIFI, VBAT @ 3.3V)

| Operational State                | MCU Mode                 | Wi-Fi State           | Typ <sup>1</sup> | Max <sup>1</sup>      | Max <sup>1</sup>      | Unit |
|----------------------------------|--------------------------|-----------------------|------------------|-----------------------|-----------------------|------|
|                                  |                          |                       |                  | T <sub>A</sub> = 25°C | T <sub>A</sub> = 85°C |      |
| VBAT <sup>7</sup>                | MCU VBAT Mode, RTC on    | Wi-Fi powered off     | 0.97             | –                     | 3.0                   | µA   |
| Standby <sup>7</sup>             | MCU Standby Mode, RTC on | Wi-Fi powered off     | 3.8              | 5.0                   | 17.0                  | µA   |
| Stop <sup>3,7</sup>              | MCU Stop Mode            | Wi-Fi powered off     | 10               | 28                    | 230                   | µA   |
| Wi-Fi Powersave <sup>2,3</sup>   | MCU Stop mode            | Wi-Fi in powersave    | 0.77             | –                     | –                     | mA   |
| Active Receive <sup>2,3,4</sup>  | MCU Stop mode            | Wi-Fi active receive  | 5.7              | –                     | –                     | mA   |
| Active Transmit <sup>2,3,5</sup> | MCU Stop mode            | Wi-Fi active transmit | 11.4             | –                     | –                     | mA   |
| Wi-Fi Tx Test Mode <sup>6</sup>  | MCU Stop mode            | Wi-Fi active transmit | –                | 320                   | –                     | mA   |

**Notes:**

1. Total combined current consumed by all power supplies: VBAT, VDD\_3V3, VDD\_WIFI.
2. 802.11 beacon Interval = 102.4ms, DTIM=3, Beacon Duration = 1ms @ 1Mbps.
3. MCU Stop Mode with 113µs wakeup latency (flash in deep power down mode), VDD\_WIFI = 0V
4. Average current receiving 1Mbit/s UDP at 802.11n MCS7
5. Average current transmitting 1Mbit/s UDP at 802.11n MCS7
6. Wi-Fi Transmitting at +18dBm CCK 11Mbit/s with maximum duty cycle
7. Hardware capability; minimum power consumption is dependent on ZentriOS version and external components connected to AMWx36 pins

## 3.4 32kHz Crystal

Table 6. 32kHz Crystal Specifications<sup>1</sup>

| Operational State   | Note                | Min | Typical | Max | Unit |
|---------------------|---------------------|-----|---------|-----|------|
| Frequency           |                     | –   | 32768   | –   | Hz   |
| Frequency Tolerance |                     | –   | 20      | –   | ppm  |
| Frequency Ageing    | Measured @25°C ±3°C | -3  | –       | +3  | ppm  |

**Notes:**

1. Reproduced from manufacturer's datasheet.

## 4 WLAN RF Specifications

The AMWx36 WLAN radio specifications are derived from the Cypress CYW43362 WLAN radio specifications.

Unless otherwise stated, the specifications in this section apply when the operating conditions are within the limits specified in Section 3.2, Recommended Operating Conditions. Functional operation outside these limits is not guaranteed.

All specifications are measured by disconnecting the PCB antenna and connecting directly to the RF trace.

### 4.1 Summary WLAN Specifications

Table 7. Summary WLAN Specifications

| Feature Supported                 | Description   |
|-----------------------------------|---|
| WLAN Standard                     | IEEE 802.11b/g/n 1x1 SISO   |
| Frequency Band                    | 2.400 GHz – 2.484 GHz   |
| WLAN Channels                     | Channels 1 – 13   |
| Data Rates                        | 802.11b (1, 2, 5.5, 11 Mbps)<br>802.11g (6, 9, 12, 24, 36, 48, 54 Mbps)<br>802.11n (HT20 MCS0-MCS7)                                       |
| Maximum Receive level<br>@ 2.4GHz | -2.5 dBm @ 1, 2 Mbps (8% PER, 1024 octets)<br>-8.5 dBm @ 5.5, 11 Mbps (8% PER, 1024 Octets)<br>-12 dBm @ 6-54 Mbps (10% PER, 1000 Octets) |
| Maximum RF Tx Output Power        | +18 dBm @ 802.11b (EVM < -9 dB)<br>+14 dBm @ 802.11n MCS7 (EVM < -28 dB)  |
| Carrier Frequency Accuracy        | ±20 ppm (26MHz crystal with ±10 ppm @ 25C)  |

### 4.2 WLAN Receiver Specifications

Table 8. WLAN Receiver Performance Specifications

| Parameter   | Condition/Notes | Min  | Typical | Max  | Unit |
|---|-----------------|------|---------|------|------|
| Frequency Range   | –               | 2400 | –       | 2500 | MHz  |
| Operating Temperature <sup>1</sup>  | –               | -30  | –       | +85  | °C   |
| Receive Sensitivity <sup>2</sup><br>(8% PER for 1024 octet PSDU)                                      | 1 Mbps DSSS     | –    | -94     | -91  | dBm  |
|   | 11 Mbps CCK     | –    | -87     | -83  |      |
| Receive Sensitivity <sup>2</sup><br>(10% PER for 1000 octet PSDU) at either antenna port <sup>3</sup> | 6 Mbps OFDM     | –    | -86     | -81  | dBm  |
|   | 54 Mbps OFDM    | –    | -73     | -69  |      |

| Parameter   | Condition/Notes                      | Min   | Typical | Max | Unit |
|---|--------------------------------------|-------|---------|-----|------|
| Receive Sensitivity <sup>2</sup><br>(10% PER for 4096 octet PSDU). Defined for default parameters: GF, 800ns GI, and non-STBC | 65 Mbps MCS0, HT20                   | –     | -86     | -81 | dBm  |
|   | 65 Mbps MCS7, HT20                   | –     | -70     | -65 |      |
| Max. Receive Level @ 2.4GHz   | @ 1, 2 Mbps (8% PER, 1024 octets)    | -2    | –       | –   | dBm  |
|   | @ 5.5, 11 Mbps (8% PER, 1024 Octets) | -8    | –       | –   |      |
|   | @ 6-54 Mbps (10% PER, 1000 Octets)   | -11.5 | –       | –   |      |

**Notes:**

1. Operation below -20°C and above +65°C with parameter derating per Note 2
2. Derate receive sensitivity by 1.5dB for operation between temperatures of -30°C to -20°C and 65°C to 85°C

## 4.3 WLAN Transmitter Specifications

Table 9. WLAN Transmitter Performance Specifications

| Parameter   | Condition/Notes       |        | Min  | Typical | Max  | Unit |
|---|-----------------------|--------|------|---------|------|------|
| Frequency Range   | —                     |        | 2400 | —       | 2500 | MHz  |
| Operating Temperature <sup>1</sup>  | —                     |        | -30  | —       | +85  | °C   |
| Transmit power <sup>2</sup> for highest power level setting at 25°C, VDD-3V3_RF_IN=3.3V with spectral mask and EVM compliance | EVM does NOT exceed : |        |      |         |      |      |
|   | 1 Mbps DSSS           | -11 dB | +14  | +16     | +18  | dBm  |
|   | 11 Mbps CCK           | -11 dB | +14  | +16     | +18  |      |
|   | 6 Mbps OFDM           | -22 dB | +12  | +14     | +16  |      |
|   | 54 Mbps OFDM          | -25 dB | +12  | +14     | +16  |      |
|   | MCS0, HT20            | -22 dB | +10  | +12     | +14  |      |
|   | MCS7, HT20            | -28 dB | +10  | +12     | +14  |      |

**Notes:**

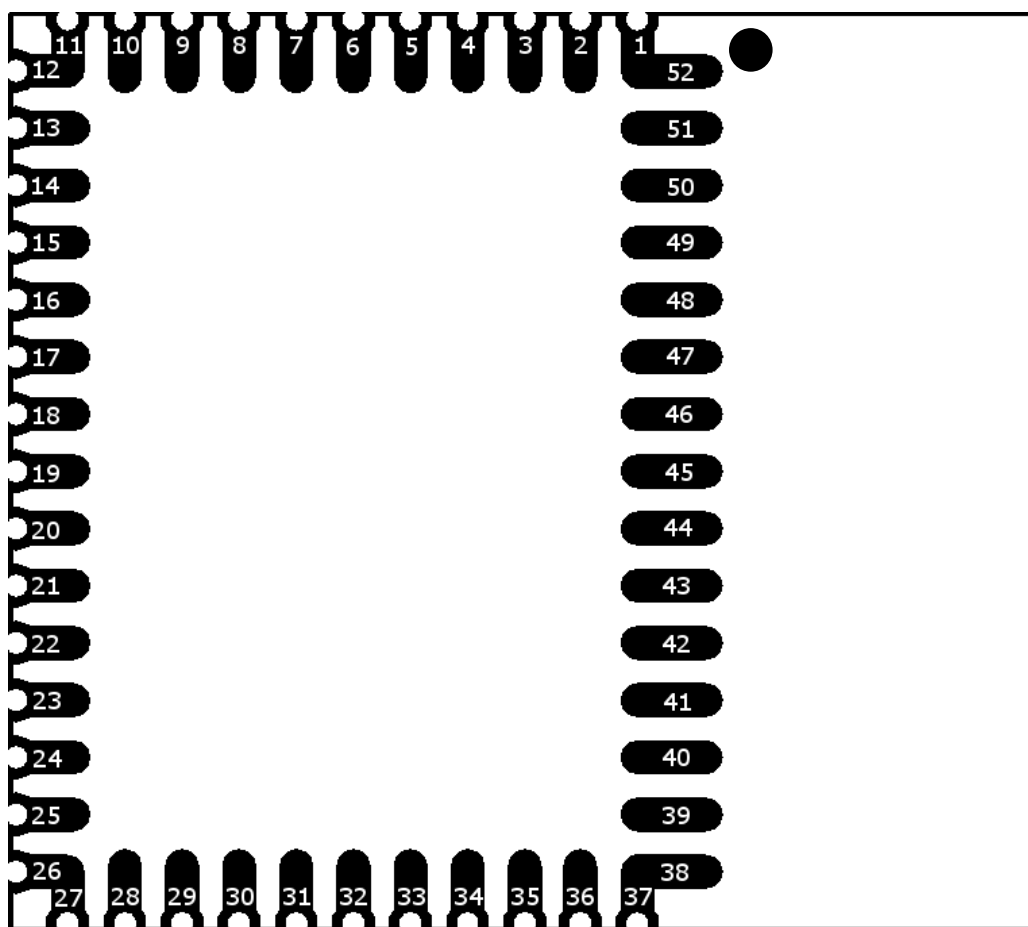
1. Operation below -20°C and above +65°C with parameter derating per Note 2
2. Derate transmit power by 1.5dB for operation between temperatures of -30°C to -20°C and 65°C to 85°C

## 5 Pinout and Signal Descriptions

### 5.1 Pinout

A top view of the AMWx36 pinout is depicted in Figure 2. All dimensions are in thousands of an inch. A recommended footprint is provided in Section 6.2.

Figure 2. AMWx36 Pinout (TOP View – Pins NOT visible from top!)



### 5.2 Pin Description

Table 10. AMWx36 ZentriOS Pin Definitions

| Pin | Name   | Type <sup>1</sup> | Primary Function           | Alternate & Other Function(s) |
|-----|--------|-------------------|----------------------------|-------------------------------|
| 1-2 | GND    | S                 | Ground                     | -                             |
| 3   | VBAT   | S                 | VBAT MCU supply            | -                             |
| 4   | GPIO_0 | I/O               | Factory Reset <sup>2</sup> | SPI1_MISO (S), GPIO           |
| 5   | GPIO_1 | I/O               | GPIO                       | -                             |

| Pin   | Name        | Type <sup>1</sup> | Primary Function           | Alternate & Other Function(s)                                 |
|-------|-------------|-------------------|----------------------------|---|
| 6     | GPIO_2      | I/O               | GPIO                       | SPI1_SCK (S)  |
| 7     | GPIO_3      | I/O               | GPIO                       | SPI1_CS (S)   |
| 8     | GPIO_4      | I/O               | GPIO                       | -   |
| 9     | OSC_32K_OUT | O                 | OSC_32K_OUT                | -   |
| 10    | VDD_3V3     | I/O               | 3.3V MCU supply            |   |
| 11-12 | GND         | S                 | Ground                     | -   |
| 13    | GPIO_5      | I/O               | GPIO                       | SPI1_MOSI (slave), PWM5                                       |
| 14    | GPIO_6      | I/O               | SPI0_MISO (M) <sup>4</sup> | ADC6 (when SPI not in use).<br>Not available for digital I/O. |
| 15    | GPIO_7      | I/O               | SPI0_SCK (M) <sup>4</sup>  | ADC5 (when SPI not in use).<br>Not available for digital I/O. |
| 16    | GPIO_8      | I/O               | SPI0_MOSI (M) <sup>4</sup> | ADC7 (when SPI not in use).<br>Not available for digital I/O. |
| 17    | GPIO_9      | I/O               | GPIO                       | UART0_RTS   |
| 18    | GPIO_10     | I/O               | GPIO                       | UART0_CTS, PWM0   |
| 19    | GPIO_11     | I/O               | UART0_RX                   | GPIO, PWM0  |
| 20    | GPIO_12     | I/O               | UART0_TX                   | GPIO, PWM0  |
| 21    | GPIO_13     | I/O               | GPIO                       | PWM1  |
| 22    | GPIO_14     | I/O               | GPIO                       | PWM3, I2C_SCL   |
| 23    | GPIO_15     | I/O               | GPIO                       | PWM3, I2C_SDA   |
| 24    | GPIO_16     | I/O               | GPIO                       | PWM6  |
| 25    | GPIO_17     | I/O               | GPIO                       | UART1_RX, ADC3, PWM4  |
| 26-27 | GND         | I/O               | Ground                     | -   |
| 28    | GPIO_18     | I/O               | GPIO                       | -   |
| 29    | GPIO_19     | I/O               | GPIO                       | UART1_TX, ADC2, PWM4  |
| 30    | GPIO_20     | I/O               | GPIO                       | ADC9, PWM2  |
| 31    | GPIO_21     | I/O               | GPIO                       | ADC8, PWM2  |
| 32    | GPIO_22     | I/O               | GPIO                       | UART1_CTS, WAKE, ADC0, PWM1                                   |
| 33    | GPIO_23     | I/O               | GPIO                       | UART1_RTS, ADC1, PWM4   |
| 34    | RESET_N     | I                 | System Reset <sup>3</sup>  |   |
| 35    | VDD_WIFI    | S                 | 3.3V WLAN supply           | -   |
| 36-52 | GND         | S                 | Ground                     | -   |

**Notes:**

1. *I = Input, O = Output, S = Supply*
2. *Factory reset is sampled at power-on-reset and available for other purposes thereafter.*
3. *The module Reset pin is connected to the internal MCU via a 1k resistor.  
We recommend driving the pin. If the pin is not driven, connect a 0.1uF capacitor to ground close to the pin to bypass noise which may cause unintended reset.*
4. *Connected to SPI serial flash inside the module.*

## 6 Design Guidelines

### 6.1 Dimensions

Figure 3 - AMWx36 Numbat Dimensions

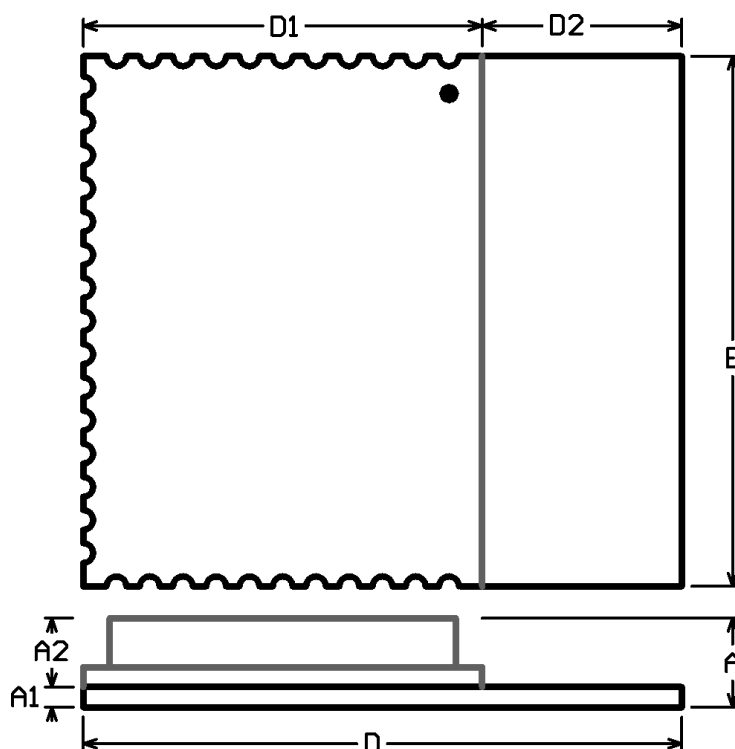


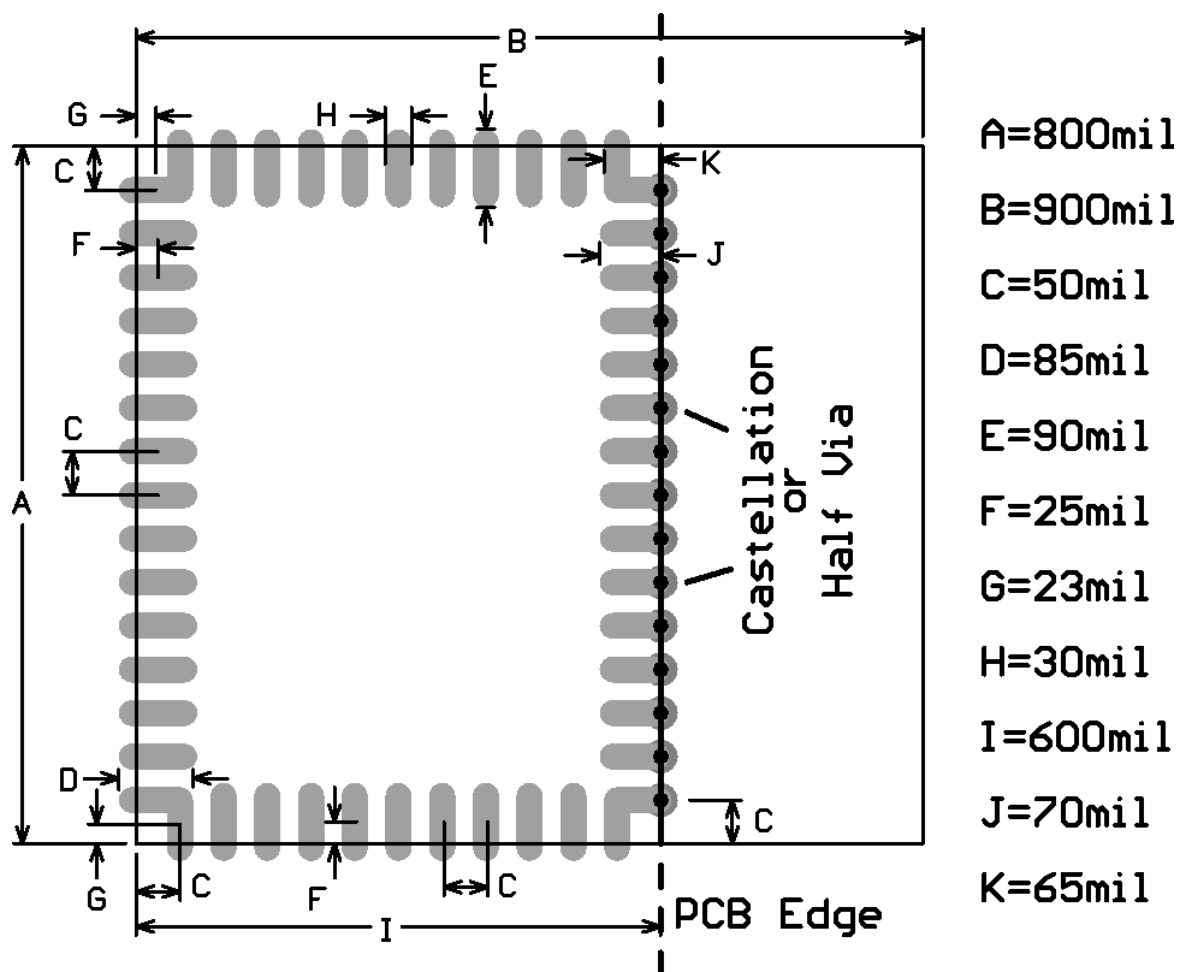
Table 11 - AMWx36 Numbat Dimensions

| Symbol | Imperial (thou) | Tolerance (thou) | Metric (mm) | Tolerance (mm) |
|--------|-----------------|------------------|-------------|----------------|
| A      | 134             | ±6               | 3.40        | ±0.15          |
| A1     | 30              | ±3               | 0.76        | ±0.08          |
| A2     | 104             | ±6               | 2.64        | ±0.15          |
| D      | 900             | ±5               | 22.86       | ±0.13          |
| D1     | 600             | ±5               | 15.24       | ±0.13          |
| D2     | 300             | ±5               | 7.62        | ±0.13          |
| E      | 800             | ±5               | 20.32       | ±0.13          |

## 6.2 Recommended PCB Footprint

All dimensions in Figure 4 are in thousands of an inch unless otherwise marked.

Figure 4. AMWx36 Recommended Footprint (Top)



## 6.3 Routing Recommendations

When designing a carrier board, the addition of ground fill directly underneath the AMWx36 module, rather than signal or power traces, is recommended. All ground pads must be connected to a solid ground plane. Failure to comply with these recommendations may result in degraded performance of WLAN functionality.

6.4 Soldering Information

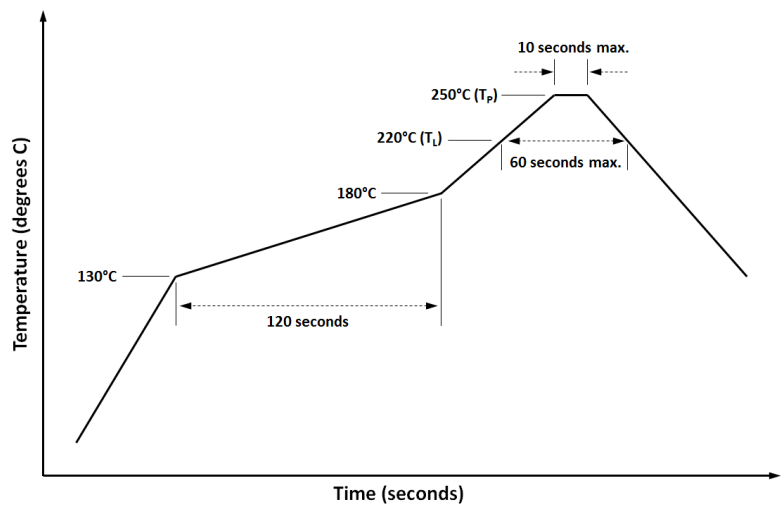


Figure 5 - Recommended solder reflow profile

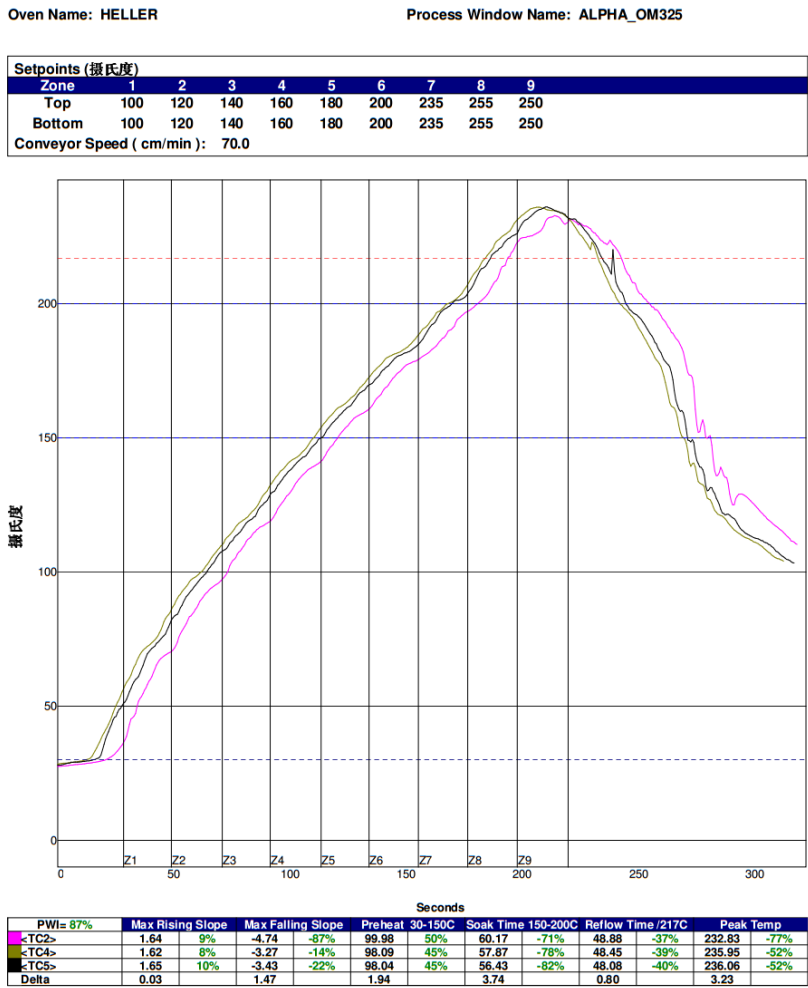


Figure 6 - Example solder reflow profile (AMWx36-E03 evaluation board)

## 6.5 Module Photograph

Figure 7. AMW036 Image (Top)



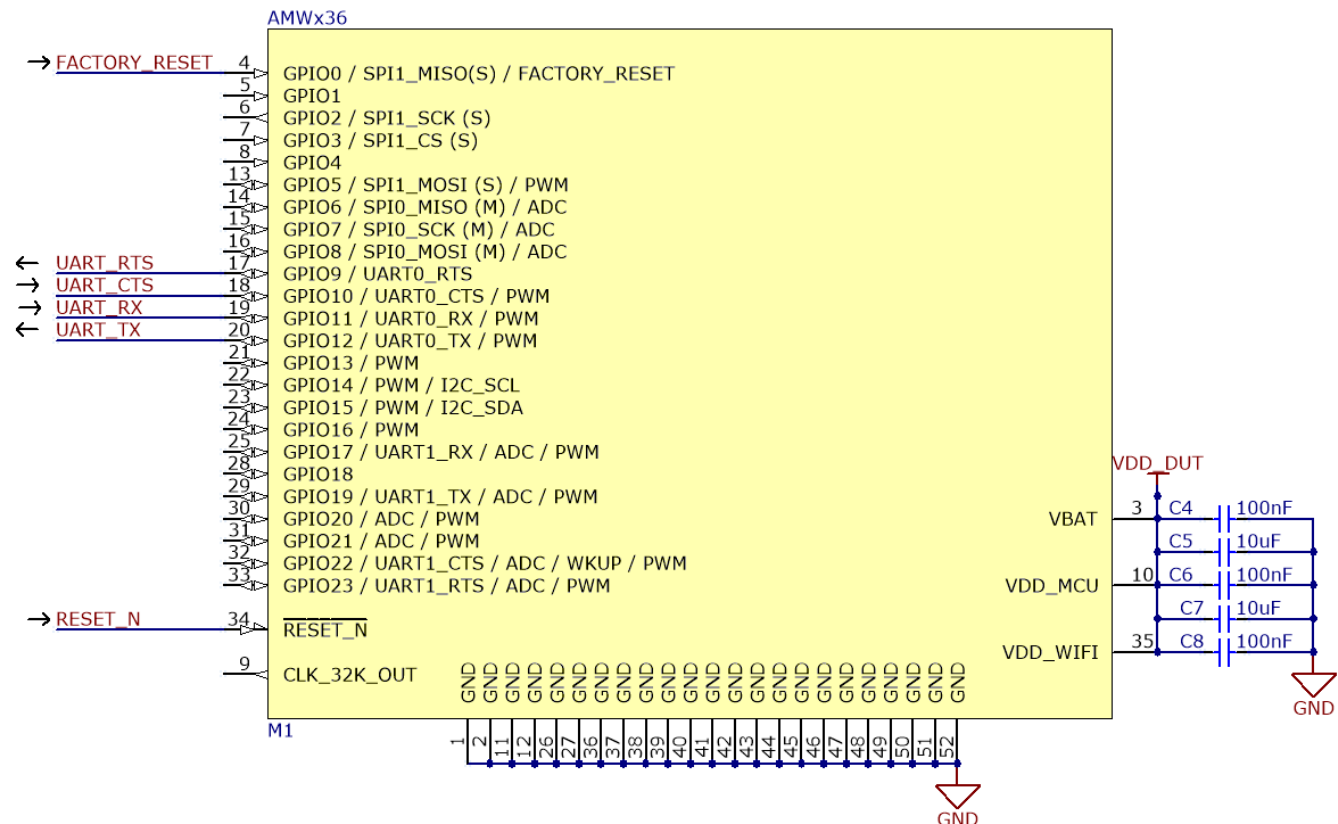
## 6.6 Application Examples

### 6.6.1 Operation using ZentriOS Serial Interface

Each AMWx36 module is pre-installed with and licensed to use ZentriOS, Zentri's feature-rich and reliable Wi-Fi networking application. The AMW036 and AMW136 modules can be used with an external host microcontroller via the serial interface command API. The AMW136 module can also be used via a Native API app running on the internal microcontroller.

To use Zentri's easy-to-use ZentriOS serial-to-Wi-Fi application, the module only requires an external connection to power and a UART serial interface. A host processor connects to UART0 (pins 17-20) as shown in Figure 8.

Figure 8. Using the AMWx36 Module with ZentriOS and a UART serial interface



## 7 Regulatory Certification

The AMWx36 module has been certified for operation in various regulatory domains. This section outlines certification information specific to the following countries and regions:

- United States
- Canada
- Europe
- Australia
- New Zealand
- Japan

The certifications listed in this section are valid at the time of publication. For up-to-date information refer to Zentri documentation online at:

<https://docs.zentri.com>.

All AMWx36 test reports are available on the Zentri website:

<https://docs.zentri.com/zentri/docresources#amw036>

Should you require regulatory certification for the AMWx36 module in a country or region not listed, please contact your local Zentri sales office or create a support request via our website at <https://www.silabs.com/about-us/contact-us>.

### 7.1 United States

The Zentri AMWx36 module has received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Sub-part C “Intentional Radiators” modular approval in accordance with Part 15.212 Modular Transmitter approval. Modular approval allows the end user to integrate the AMWx36 module into a finished product without obtaining subsequent and separate FCC approvals for intentional radiation, provided no changes or modifications are made to the module circuitry. Changes or modifications could void the user’s authority to operate the equipment. The end user must comply with all of the instructions provided by the Grantee which indicate installation and/or operating conditions necessary for compliance.

The finished product is required to comply with all applicable FCC equipment authorization, regulations, requirements, and equipment functions not associated with the transmitter module portion. For example,

compliance must be demonstrated to regulations for other transmitter components within the host product; to requirements for unintentional radiators (Part 15 Sub-part B “Unintentional Radiators”), such as digital devices, computer peripherals, radio receivers, etc.; and to additional authorization requirements for non-transmitter functions on the transmitter module (i.e. Verification, or Declaration of Conformity) (e.g., transmitter modules may also contain digital logic functions) as appropriate.

#### 7.1.1 Labeling and User Information Requirements

The AMWx36 module has been labelled with a unique FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording as follows:

Contains FCC ID: 2ABPY-B5BD9  
This device complies with Part 15 of the FCC Rules.  
Operation is subject to the following two conditions:  
(1) this device may not cause harmful interference,  
and (2) this device must accept any interference  
received, including interference that may cause  
undesired operation.

The user manual for the product should include the following statement:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Additional information on labeling and user information requirements for Part 15 devices can be found in KDB Publication 784748 available at the FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB) at the following website: <http://www.fcc.gov>

### 7.1.2 RF Exposure

All transmitters regulated by FCC must comply with RF exposure requirements. OET Bulletin 65, Evaluating Compliance with FCC Guidelines for Human Exposure to Radio Frequency Electromagnetic Fields, provides assistance in determining whether proposed or existing transmitting facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC). The bulletin offers guidelines and suggestions for evaluating compliance.

If appropriate, compliance with exposure guidelines for mobile and unlicensed devices can be accomplished by the use of warning labels and by providing users with information concerning minimum separation distances from transmitting structures and proper installation of antennas.

The following statement must be included as a CAUTION statement in manuals and OEM products to alert users of FCC RF exposure compliance:

To satisfy FCC RF Exposure requirements for mobile and base station transmission devices, a separation distance of 20 cm or more should be maintained between the antenna of this device and persons during operation. To ensure compliance, operation at closer than this distance is not recommended. The antenna(s) used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter

If the AMWx36 module is used in a portable application (i.e., the antenna is less than 20 cm from persons during operation), the integrator is responsible for performing Specific Absorption Rate (SAR) testing in accordance with FCC rules 2.1091.

### 7.1.3 Further Information

Additional information regarding FCC certification and use of the AMWx36 module in the United States is available from the following sources.

- Federal Communications Commission (FCC)  
<http://www.fcc.gov>

## 7.3 Canada

The AMWx36 module has been certified for use in Canada under Industry Canada (IC) Radio Standards Specification (RSS) RSS-210 and RSSGen. Modular approval permits the installation of a module in a host device without the need to recertify the device.

### 7.3.1 Labeling and User Information Requirements

Labeling Requirements for the Host Device (from Section 3.2.1, RSS-Gen, Issue 3, December 2010): The host device shall be properly labeled to identify the module within the host device.

The Industry Canada certification label of a module shall be clearly visible at all times when installed in the host device, otherwise the host device must be labeled to display the Industry Canada certification number of the module, preceded by the words “Contains transmitter module”, or the word “Contains”, or similar wording expressing the same meaning, as follows:

Contains transmitter module IC: 11685A-61F8D

User Manual Notice for License-Exempt Radio Apparatus (from Section 7.1.3 RSS-Gen, Issue 3, December 2010): User manuals for license-exempt radio apparatus shall contain the following or equivalent notice in a conspicuous location in the user manual or alternatively on the device or both:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Transmitter Antenna Notification (from Section 7.1.2 RSS-Gen, Issue 3, December 2010): User manuals for transmitters shall display the following notice in a conspicuous location:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (EIRP) is not more than that necessary for successful communication.

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

The above notice may be affixed to the device instead of displayed in the user manual.

User manuals for transmitters equipped with detachable antennas shall also contain the following notice in a conspicuous location:

This radio transmitter (identify the device by certification number, or model number if Category II) has been approved by Industry Canada to operate with the antenna types listed below with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Le présent émetteur radio (identifier le dispositif par son numéro de certification ou son numéro de modèle s'il fait partie du matériel de catégorie I) a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés ci-dessous et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

Immediately following the above notice, the manufacturer shall provide a list of all antenna types approved for use with the transmitter, indicating the maximum permissible antenna gain (in dBi) and required impedance for each.

### 7.3.2 Further Information

Additional information may be obtained from the Industry Canada website at <http://www.ic.gc.ca>

## 7.5 Europe

The AMWx36 module is a Radio Equipment Directive (RED) assessed radio module that is CE marked and has been manufactured and tested with the intention of being integrated into a final product.



The AMW036 and AMW136 modules have been tested to Radio Equipment Directive (2014/53/EU) and R&TTE Directive (1999/5/EC).

See:

[AMWxx6 Numbat CE Certification Package](#)

Opinion has also been issued.

The R&TTE Compliance Association provides guidance on modular devices in the document titled Technical Guidance Note 01.

NOTE: To maintain conformance to the testing listed in Table 12. European Compliance Testing, the module shall be installed in accordance with the installation instructions in this data sheet and shall not be modified.

When integrating a radio module into a completed product the integrator becomes the manufacturer of the final product and is therefore responsible for demonstrating compliance of the final product with the essential requirements of the R&TTE Directive.

### 7.5.1 Labeling and User Information Requirements

The label on the final product which contains the AMWx36 module must follow CE marking requirements. The R&TTE Compliance Association Technical Guidance Note 01 provides guidance on final product CE marking.

### 7.5.2 Further Information

Further information may be obtained by searching for:

- European Conference of Postal and Telecommunications Administrations (CEPT)
- Radio Equipment Directive (RED), which replaces Radio and Telecommunications Terminal Equipment (R&TTE)

**Table 12. European Compliance Testing**

| Certification         | Standard   | Report Number    | Date         | Laboratory                                    |
|-----------------------|--|------------------|--------------|---|
| Safety                | EN 60950-1:2006, A11:2009, A1:2010, A12:2011, A2:2013                    | W6M21410-14584-L | Jan 15, 2015 | Worldwide Testing Services (Taiwan) Co., Ltd. |
| EMF                   | EN 62311:2008  | EA560122         | Jul 1, 2015  | Sporton International, Inc. (Taiwan)          |
| EMC                   | EN 301 489-1 v2.1.1 (2016-11), Class B<br>EN 301 489-17 v3.1.1 (2016-11) | 21274926_001     | Jul 11, 2017 | TÜV Rheinland                                 |
|                       | EN 55022:2010/AC:2011, Class B<br>EN 55024:2010                          | EA560122         | Jul 1, 2015  | Sporton International, Inc. (Taiwan)          |
| Radio                 | EN 300 328 v2.1.1 (2016-11)  | 21274936_001     | Jul 10, 2017 | TÜV Rheinland                                 |
| Notified Body Opinion | <b>CE1177</b>  | TCF-1334TC15     | Jul 5, 2015  | TIMCO Engineering, Inc.                       |

## 7.6 Australia

Australian radio regulations do not provide a modular approval policy similar to the United States (FCC) or Canada (IC). However, AMWx36 module test reports may be used in part to demonstrate compliance in accordance with ACMA Radio communications “Short Range Devices” Standard 2004 which references Australia/New Zealand industry standard AS/NZS-4268:2012. AMWx36 RF transmitter test reports may be used as part of the product certification and compliance folder. For further information regarding the availability of RF test reports, please contact Zentri via our website at <https://www.silabs.com/about-us/contact-us>.

### 7.6.1 Further Information

Additional information may be obtained from the Australian Communications and Media Authority website at <http://www.acma.gov.au>.

## 7.7 New Zealand

New Zealand radio regulations do not provide a modular approval policy similar to the United States (FCC) or Canada (IC). However, AMWx36 module test reports may be used in part to demonstrate compliance with the New Zealand “General User Radio License for Short Range Devices”. New Zealand Radio communications (Radio Standards) Notice 2010 references Australia/New Zealand industry standard AS/NZS-4268:2012. AMWx36 RF transmitter test reports may be used as part of the product certification and compliance folder. For further information regarding the availability of RF test reports, please contact Zentri via our website at <https://www.silabs.com/about-us/contact-us>.



### 7.7.1 Further Information

Additional information may be obtained from the New Zealand Radio Spectrum Ministry of Economic Development website at <http://www.rsm.govt.nz>.

## 7.8 Japan

The AMWx36 has been tested to comply with the radio regulations set forth by the Japanese Ministry of Internal Affairs and Communications (MIC) as documented in Table 13. The module is certified for operation with the antenna supplied.

**Table 13. Japan Compliance Testing**

| Certification              | Standard   | Report Number   | Date        | Laboratory                           |
|----------------------------|--|-----------------|-------------|--------------------------------------|
| Verification of Compliance | VCCI V-3/2014.04 Class B ITE   | JV560122        | Jul 1, 2015 | Sporton International, Inc. (Taiwan) |
| Radio                      | Notice No. 88 Appendix No. 43  | JRF560122       | Jul 1, 2015 |                                      |
| Equipment Marking          |   201-150256 | 152150256/AA/00 | Jul 6, 2015 | Telefication, BV. (The Netherlands)  |

## 8 Packaging, Handling and Storage, RoHS

### 8.1 Packaging

Modules are shipped in cut tape, with ESD-safe packaging, or in reels.

For package quantity, see section 9, Ordering Information.

Reels are shipped inside a moisture resistant sealed bag. The shelf life of the sealed reel is 12 months at 40°C and <90% Relative Humidity (RH). Please refer to the bag seal date and the following section for handling & storage.

Ensure that all modules are managed in accordance with Moisture Sensitive Level 3 (MSL3) per **IPC/JEDEC J-STD-20**.

AMWx36 modules should be hand-soldered **ONLY**. If reflow is required, AMWx36 modules must be baked first according to Joint Industry Standard J-STD-033C.

### 8.2 Handling & Storage



#### **CAUTION** **MSL3 Sensitive Device!**

The AMWx36 module is a moisture sensitive device rated at Moisture Sensitive Level 3 (MSL3) per **IPC/JEDEC J-STD-20**.

After opening the moisture sealed storage bag, modules that will be subjected to reflow solder or other high temperature processes must be:

1. mounted to a circuit board within 168 hours at factory conditions ( $\leq 30^{\circ}\text{C}$  and  $< 60\% \text{ RH}$ )

**OR**

2. continuously stored per **IPC/JEDEC J-STD-033**

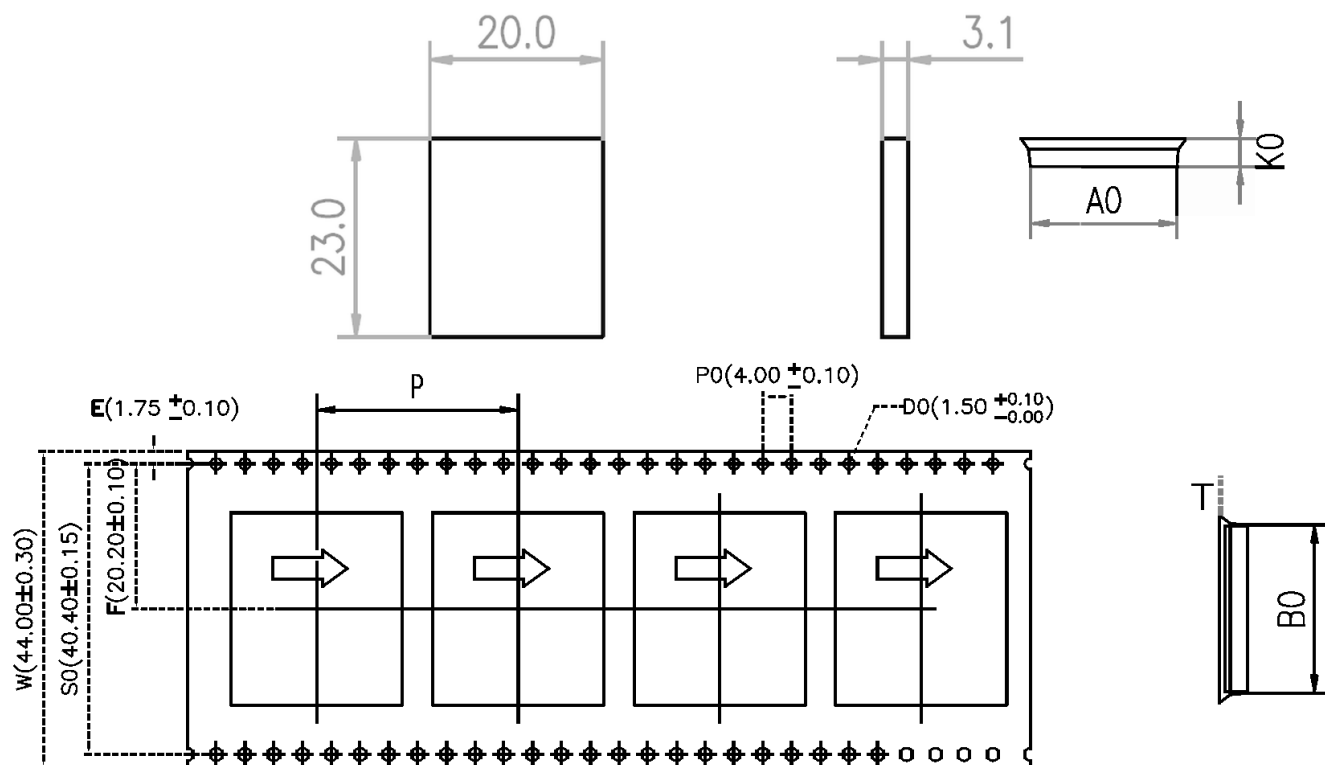
Modules that have been exposed to moisture and environmental conditions exceeding packaging and storage conditions **MUST** be baked before mounting according to **IPC/JEDEC J-STD-033**.

Failure to meet packaging and storage conditions will result in irreparable damage to modules during solder reflow.

### 8.3 RoHS Directive

The AMWx36 module is produced according to the RoHS (Restriction of the use of certain Hazardous Substances in electrical and electronic equipment) directive and complies with the directive.

## 8.4 Tape and Reel Specifications



| A0             | B0             | D0            | E             | F              | K0            | P              | P0            | S0             | T             | W             |
|----------------|----------------|---------------|---------------|----------------|---------------|----------------|---------------|----------------|---------------|---------------|
| 20.40<br>±0.10 | 23.40<br>±0.10 | 1.50<br>±0.10 | 1.75<br>±0.10 | 20.20<br>±0.10 | 3.90<br>±0.10 | 28.00<br>±0.10 | 4.00<br>±0.10 | 40.40<br>±0.15 | 0.30<br>±0.05 | 44.0<br>±0.30 |

- All dimensions in mm unless otherwise specified
- Sprocket hole pitch cumulative tolerance  $\pm 0.2\text{mm}$
- Carrier camber not to exceed 1mm in 100mm
- All dimensions meet EIA-481C requirements
- Material: PS black polystyrene
- Thickness:  $0.30 \pm 0.05\text{mm}$
- Packing length per 13" reel: 24.6 meters.
- Component load per 13" reel: 500pcs
- This product conforms to ROHS environmental protection

## 9 Ordering Information

You can order AMWx36 as either cut tape loaded with an unspecified ZentriOS, or as a full reel of **500** units pre-loaded with either a specific ZentriOS version or a version of your embedded custom application.

When you order, refer to the OPN (Orderable Part Number), as described below. For examples, see Table 14. Ordering Information.

### 9.1 Ordering an Unspecified ZentriOS Version

#### Order OPN: AMWx36

When ordering an unspecified ZentriOS version as cut tape, the OPN is of the form <platform>, where **<platform>** is AMW036 or AMW136.

When ZentriOS version is unspecified, orders of AMW036 or AMW136 modules ship with whatever versions of ZentriOS are available. The ZentriOS version is not guaranteed to be the same for all items shipped. Cut tape is suitable for sampling, evaluation, and pilot builds.

Upon delivery, you can update modules individually, via OTA (Over-The-Air update), with a specific firmware version.

### 9.2 Ordering a Specific ZentriOS Version or a Custom Firmware Version

#### ZentriOS version order OPN: AMWx36-x.y.zR

#### Custom firmware version OPN: AMWx36-xxxxxxR

Volume orders are delivered in reels, as indicated by the **R** suffix. To ensure consistency, an OPN is specified, corresponding to a specific version.

ZentriOS version: the OPN is of the form <platform>-x.y.zR, where **<platform>** is AMW036 or AMW136, and **x** is the major version, **y** is the minor version and **z** is the patch version.

Custom firmware version: the OPN is of the form <platform>-xxxxxx, where **<platform>** is AMW036 or AMW136, and **xxxxxx** is a unique ID indicating a specific product version. Zentri ships reels with the product version specified.

Custom firmware can be a product bundle for the AMW036 or AMW136. A custom product bundle includes a specific version of ZentriOS. An AMW136 ZAP product bundle also contains a ZAP (ZentriOS application).

Table 14. Ordering Information

| Order Type                 | Delivery Format | Quantity             | Example OPN                      |
|----------------------------|-----------------|----------------------|----------------------------------|
| Unspecified firmware       | Cut tape        | fewer than 500 units | AMW036<br>AMW136                 |
| Specified ZentriOS version | Full reel box   | 500 units            | AMW036-3.3.0R<br>AMW136-3.2.2R   |
| Custom firmware            | Full reel box   | 500 units            | AMW036-H35GHJR<br>AMW136-FG7L21R |

## 9.3 ZentriOS Version History

ZentriOS firmware revision history is available online at:

ZentriOS-W: <https://docs.zentri.com/zentrios/editions-and-versions#zentriosw>

ZentriOS-WZ: <https://docs.zentri.com/zentrios/editions-and-versions#zentrioswz>

## 10 Revision History & Glossary

### 10.1 Revision History

Table 15: Document Revision History

| Revision       | Date         | Change Description   |
|----------------|--------------|--|
| ADS-MWx36-100R | Jun 6, 2016  | Initial preliminary release  |
| ADS-MWx36-101R | Aug 29, 2017 | Revised Ordering Information. Added Dimensions section. Added Firmware Features page. Added I2C pins. Updated European Certification |

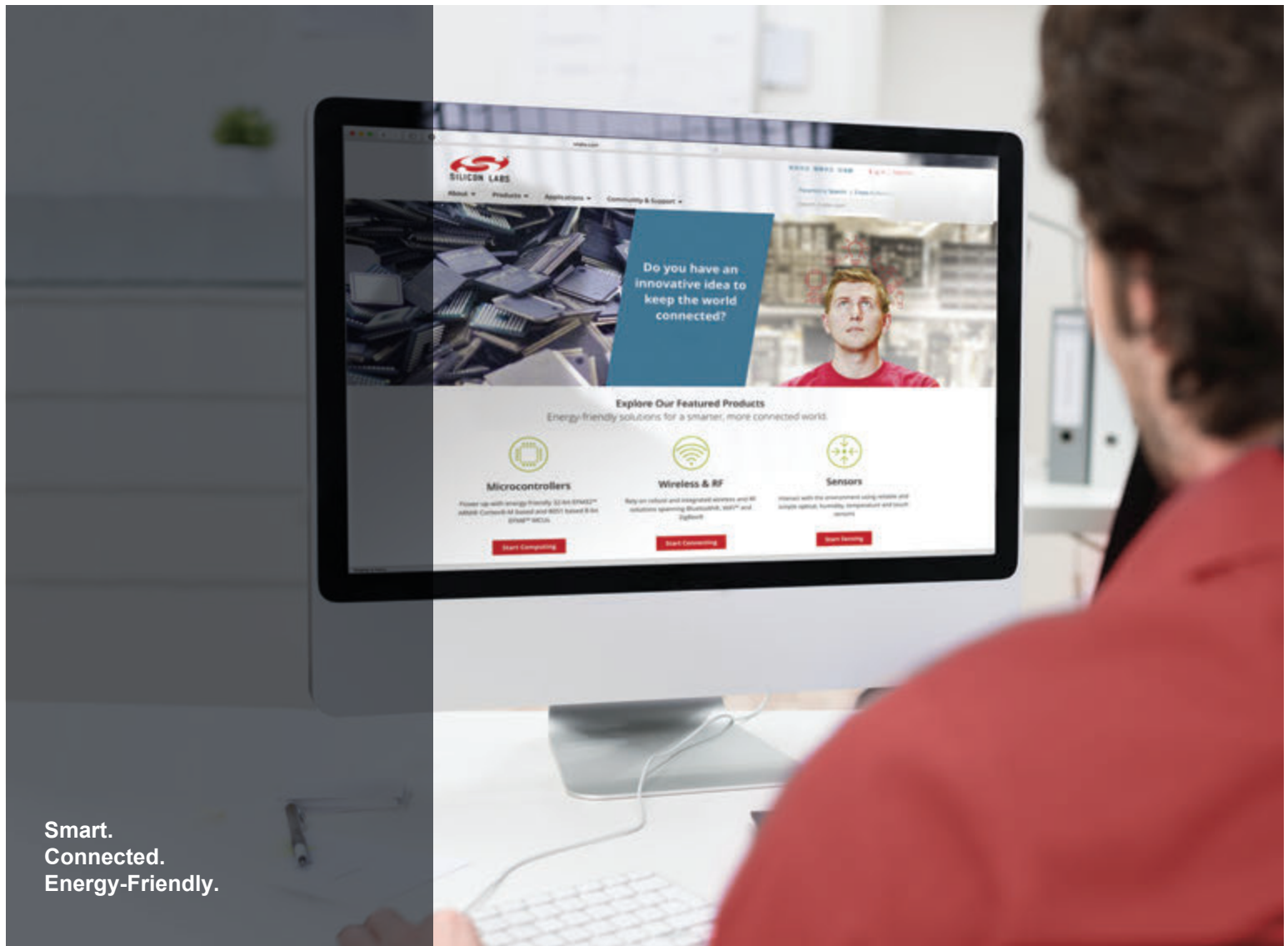
### 10.2 Glossary

In most cases, acronyms and abbreviations are defined on first use. A comprehensive list of acronyms and other terms used in Zentri documents are provided at <https://docs.zentri.com/zentri/glossary>.

## 11 References

Throughout this data sheet, references to other documents are listed. The following documents provide additional material:

1. [IEEE 802.11 Standard](http://standards.ieee.org)  
Institute of Electrical and Electronics Engineers.  
<http://standards.ieee.org>

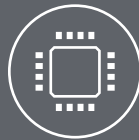


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Silicon Laboratories Inc.  
400 West Cesar Chavez  
Austin, TX 78701  
USA

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- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.